Case 5547 P1 CPI/ALUMINUM

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FORM PTD-1585 (Rev. 8-93)		OVER SI LT. U.S. Department of Community
OMB No 0651-0011 (PEP 4/84)	102177610	Patent And Trademark Office
To the Honorable Commissioner		cord the attached original document or copy thereof.
1. Name of conveying party(ies)	_	2. Name and address of receiving party(ies):
Ho Sun Wee	<u>Date</u> May 6, 2002	Name: Applied Materials, Inc.
Additional name(s) of conveying	party(ies) attached? Yes X No	Internal Address: P.O. Box 450-A
Nature of conveyance;		
X Assignment	Merger	Street Address:
Security Agreement	Change of Name	
Other		City: Santa Clara State: CA Zip: 95052
Execution Date: see above		Additional name(s) & address(es) attached?Yes X_No
4. Application number(s) or regist	tration number(s):	
If this document is being filed to	ogether with a new application, the exec	cution date of the application is: (Date of Filing)
A. Patent Application No.(s)	10/044,412 Filed 01/09/2002	CE METTER HIMERED
B. Patent No.(s)		MAY - 3 2007
Additional numbers	attached? Yes _X No	
5. Name and address of party to vidocument should be mailed;	whom correspondence concerning	Total number of applications and patents involved:
Name: Patent Count	sel	7. Total fee (37 C.F.R. 3.41)——\$ 40.00
Internal Address: API	PLIED MATERIALS, INC.	Enclosed
		Authorized to be charged to deposit account
		50-1074/AMAT/5547.P1/CPVALUMINUM/PJS
Street Address: P.O. Box 450	-A	8. Deposit account number:
		50-1074/AMAT/5547.P1/CPI/ALUMINUM/PJS
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Robert W. Mulcahy Name of Person Signing	Ci-ci-ci	1/1/1/1/ 0 /8/0Z
Harrie or cerson aidmind	Signature 2 براند المساورة الم	Date
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Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

> **PATENT** REEL: 012990 FRAME: 0299

Atty. Dkt. No. AMA [/5547.P1/CPI/ALUMINUM/PJS

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	Ki Hwan Yoon 1575 Tenaka Place #J-7 Sunnyvale, California 94087	2)	Yonghwa Chris Cha 1104 Petroni Way San Jose, California 95120
3)	Sang Ho Yu 250 West El Canino Real, Apt 1111 Sunnyvale, California 94087	4)	Hafiz Farooq Ahmad 39849 Potrero Drive Newaru, California 94560
5)	Ho Sun Wee 2250 Monroe Street, Apt. 242 Santa Clara, California 95050		

(hereinafter referred to as Assignors), have invented a certain invention entitled:

BARRIER FORMATION USING NOVEL SPUTTER-DEPOSITION METHOD

for which application for Letters Patent in the United States was filed on 01/09/2002, under Serial No. 10/044,412, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute,

1 of 2

PATENT REEL: 012990 FRAME: 0300 divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	, 2002
	Kî Hwan Yoon
2)	, 2002
	Yonghwa Chris Cha
3}	, 2002
	Sang Ho Yu
4)	, 2002
	Hafiz Farooq Ahmad
5)	5/6 2002
,	Ho Sun Wee